



Vincotech

10-PG123BA080SH11-LN68L33T

datasheet

flowBOOST 1 triple

1200 V / 80 A

Features

- High efficient three-leg booster topology
- High switching frequency with SiC components
- Low inductive layout
- Integrated NTC

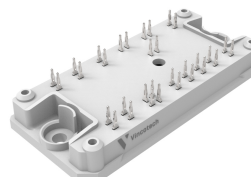
Target applications

- Solar Inverters

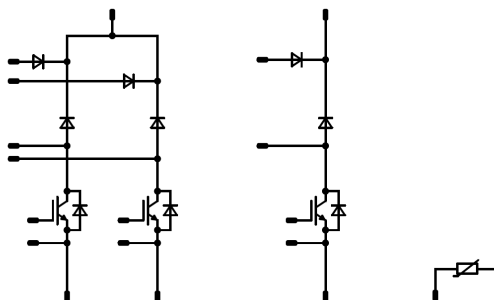
Types

- 10-PG123BA080SH11-LN68L33T

flow 1 12 mm housing



Schematic





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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	78	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	240	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	192	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	10	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Boost Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	39	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	141	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$	213	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	107	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Boost Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	47	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	270	A
Surge current capability	I^2t		370	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	61	W
Maximum junction temperature	T_{jmax}		150	$^{\circ}\text{C}$



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
ByPass Diode				
Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	94	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	600	A
Surge current capability	I^2t		1800	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	113	W
Maximum junction temperature	T_{jmax}		150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			11,53	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,003	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		80	25 125 150	1,78	1,99 2,33 2,41	2,42 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			10	µA
Gate-emitter leakage current	I_{GES}		20	0		25			240	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		4660		pF
Output capacitance	C_{oes}							300		pF
Reverse transfer capacitance	C_{res}							260		pF
Gate charge	Q_g	$V_{CC} = 960 \text{ V}$	15		80	25		370		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,5		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/15	700	80	25 125 150		27,84 27,84 27,2		ns
Rise time	t_r					25 125 150		16,64 17,92 18,88		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		240 300,8 315,2		ns
Fall time	t_f					25 125 150		31,2 71,73 83,14		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		1,55 1,96 2,09		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		3,52 5,67 6,24		mWs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Boost Diode

Static

Forward voltage	V_F				30	25 125 150		1,51 2,03 2,13	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 1200$ V				25		90	750	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,89		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=5633$ A/µs $di/dt=5438$ A/µs $di/dt=5253$ A/µs	0/15	700	80	25 125 150		28,18 27,69 26,87		A
Reverse recovery time	t_{rr}					25 125 150		10,88 11,89 11,93		ns
Recovered charge	Q_r					25 125 150		0,198 0,223 0,214		µC
Reverse recovered energy	E_{rec}					25 125 150		0,085 0,093 0,087		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		7439 6413 6090		A/µs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]		Min	Typ	Max	

Boost Sw. Protection Diode

Static

Forward voltage	V_F			28	25 125			1,15 1,11	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V			25 150				100 1000	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,15		K/W
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ByPass Diode

Static

Forward voltage	V_F			50	25 125 150			1,07 1 0,983	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V			25 150				100 2	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,62		K/W
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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Thermistor

Static

Rated resistance	R					25		5		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 499 \Omega$				100	3,2		3,3	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,3		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3380		K
Vincotech Thermistor Reference									V	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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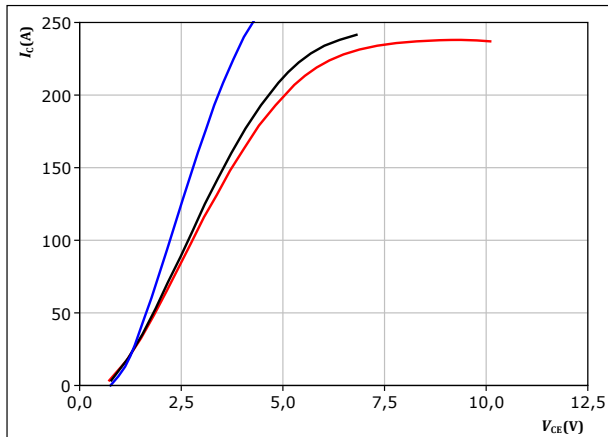
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Boost Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

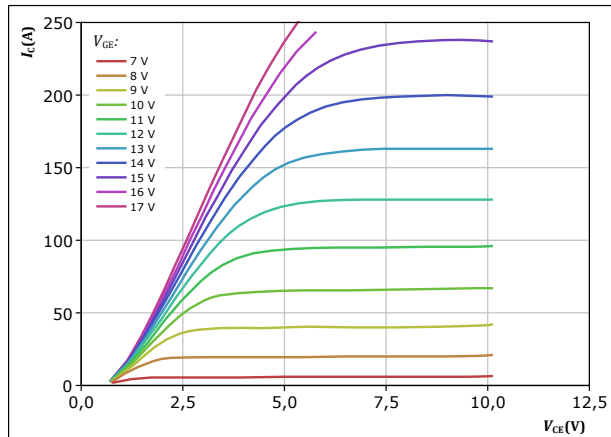


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

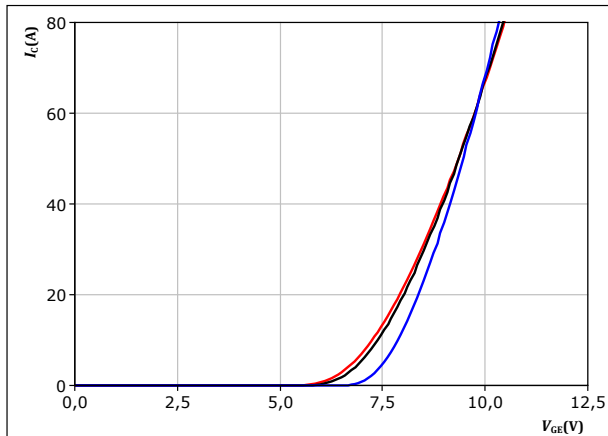


$t_p = 250 \mu s$
 $T_j = 150 ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

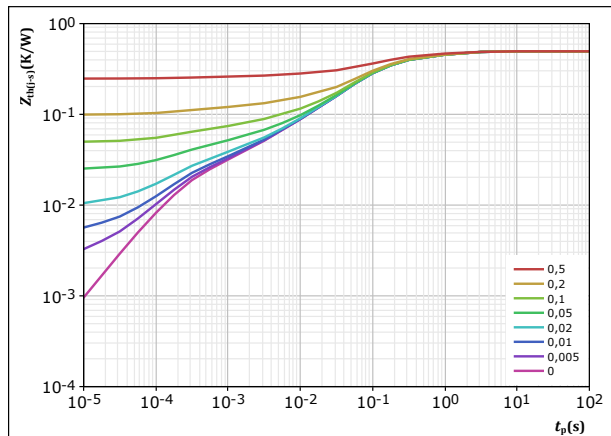


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,495 K/W$
IGBT thermal model values

$R (K/W)$	$\tau (s)$
8,27E-02	1,36E+00
1,80E-01	1,79E-01
1,82E-01	5,73E-02
3,03E-02	3,66E-03
2,06E-02	2,43E-04



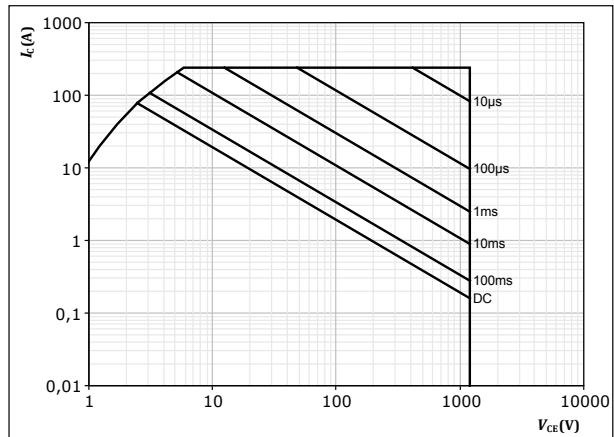
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Boost Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse

$T_s = 80$ °C

$V_{GE} = 15$ V

$T_j = T_{jmax}$



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Boost Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

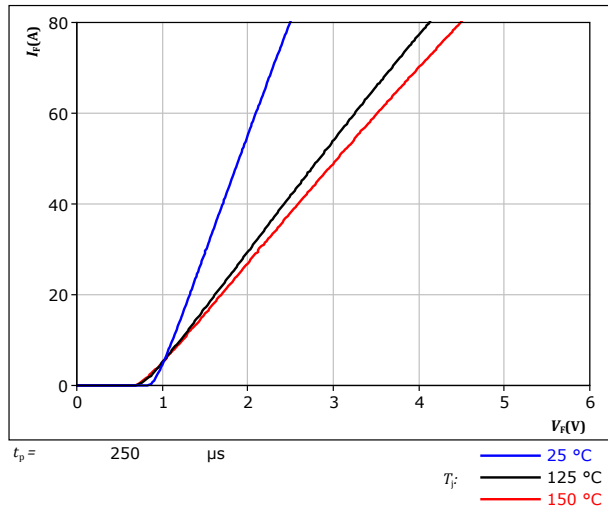
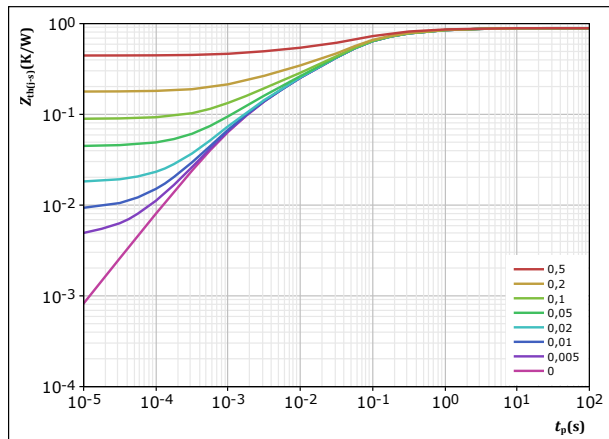


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	0,89	K/W
FWD thermal model values		
R (K/W)	τ (s)	
5,58E-02	2,38E+00	
1,74E-01	2,96E-01	
4,57E-01	5,42E-02	
1,37E-01	7,10E-03	
6,69E-02	1,23E-03	



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Boost Sw. Protection Diode Characteristics

figure 8. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

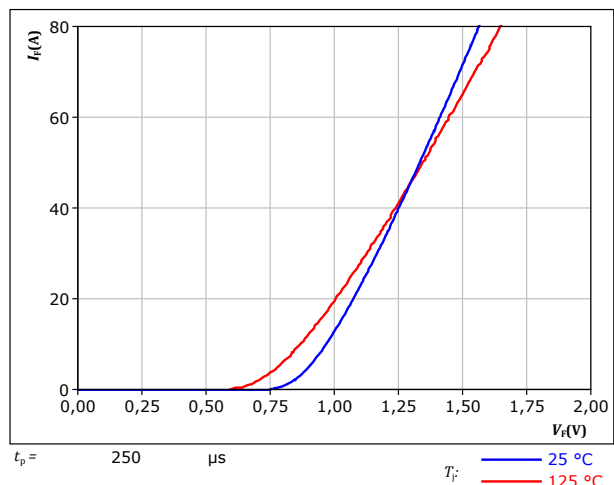
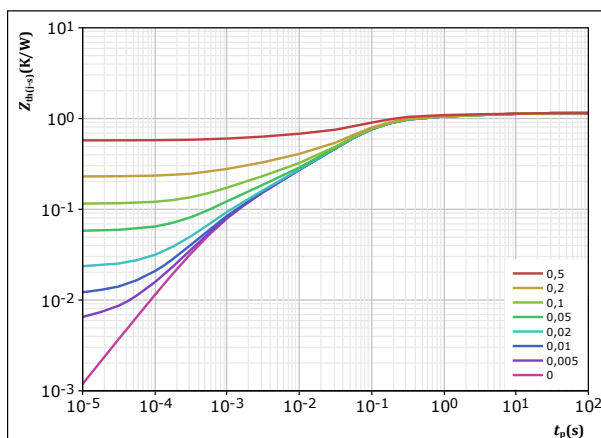


figure 9. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	1,149	K/W
Rectifier thermal model values		
R (K/W)	τ (s)	
8,29E-02	7,59E+00	
1,02E-01	6,72E-01	
4,20E-01	1,19E-01	
3,78E-01	4,22E-02	
1,08E-01	4,04E-03	
5,78E-02	7,21E-04	



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ByPass Diode Characteristics

figure 10.

Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

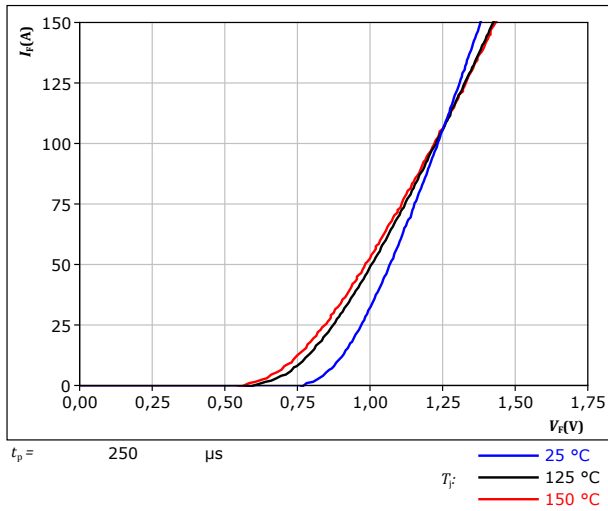
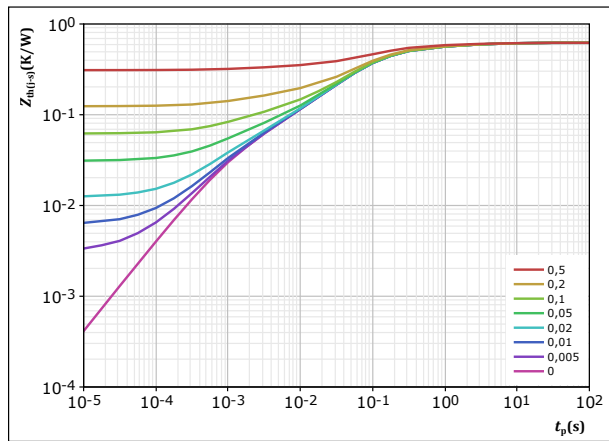


figure 11.

Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



Rectifier thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
3,05E-02	6,33E+00
7,00E-02	1,17E+00
1,92E-01	1,79E-01
2,54E-01	5,78E-02
4,42E-02	6,88E-03
2,73E-02	1,10E-03
2,83E-03	5,91E-04



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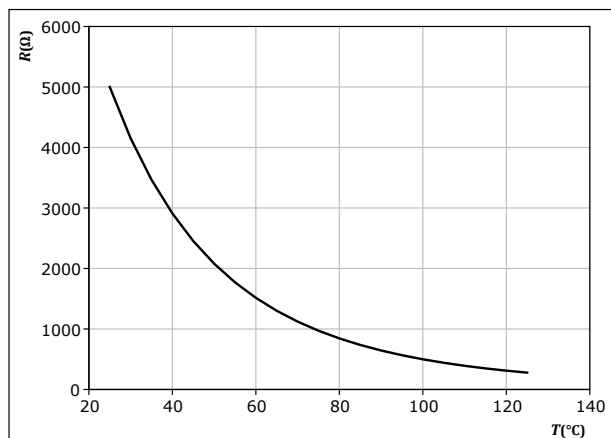
Thermistor Characteristics

figure 12.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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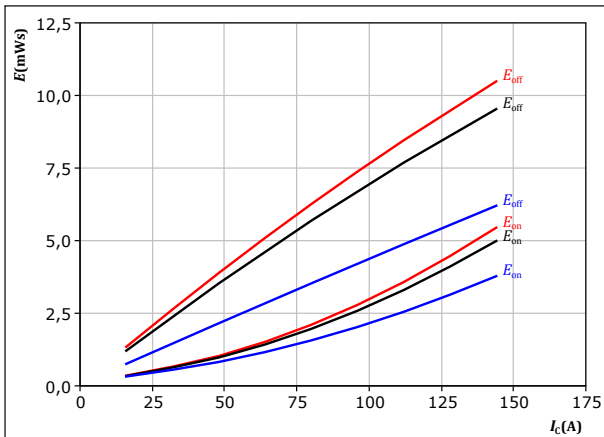
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Boost Switching Characteristics

figure 13. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

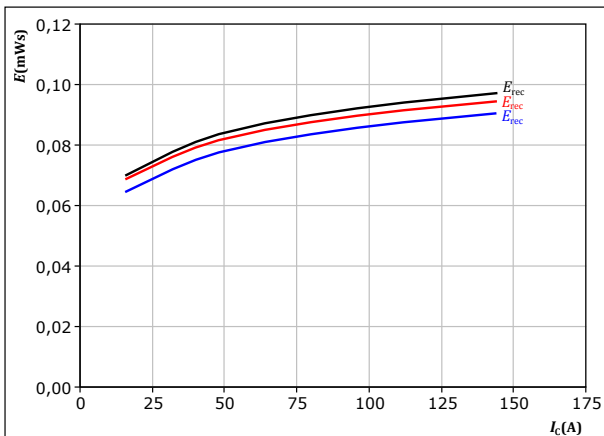
$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$
 $R_{goff} = 4 \text{ } \Omega$

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 15. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

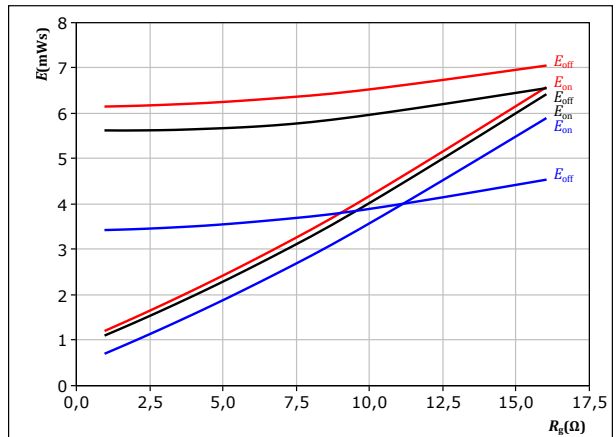
$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{gon} = 4 \text{ } \Omega$

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 14. IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

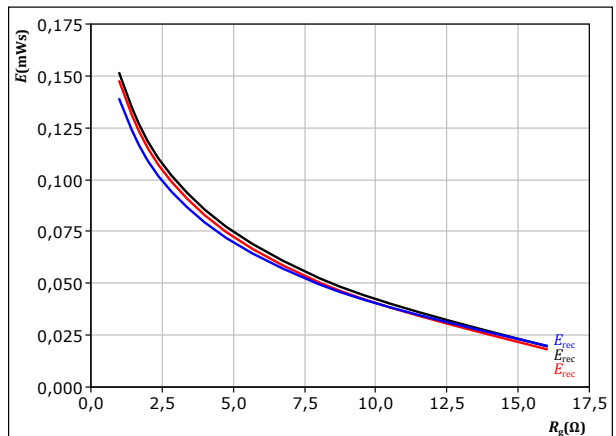
$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 80 \text{ A}$

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 16. FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_C = 80 \text{ A}$

T_j :
— 25 °C
— 125 °C
— 150 °C



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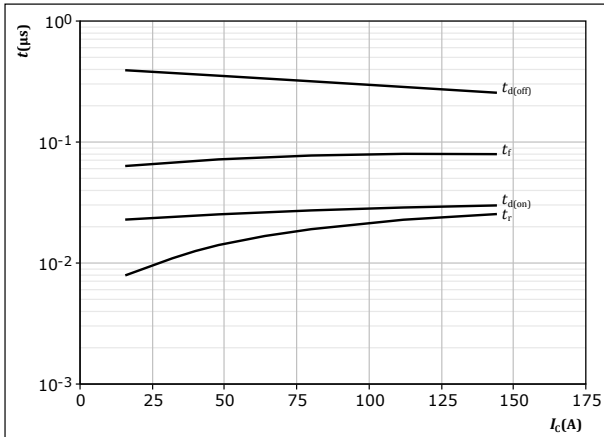
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Boost Switching Characteristics

figure 17.

IGBT

Typical switching times as a function of collector current
 $t = f(I_c)$



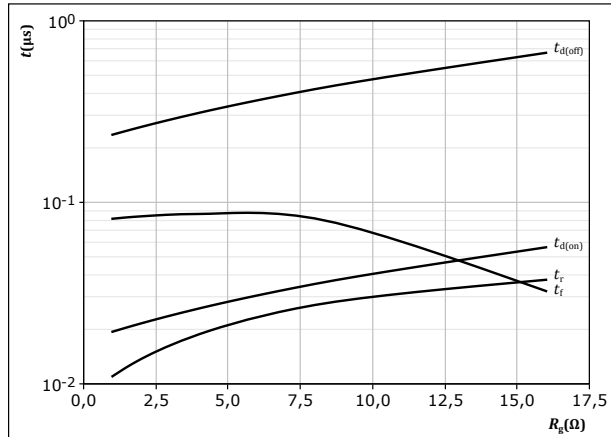
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 18.

IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$



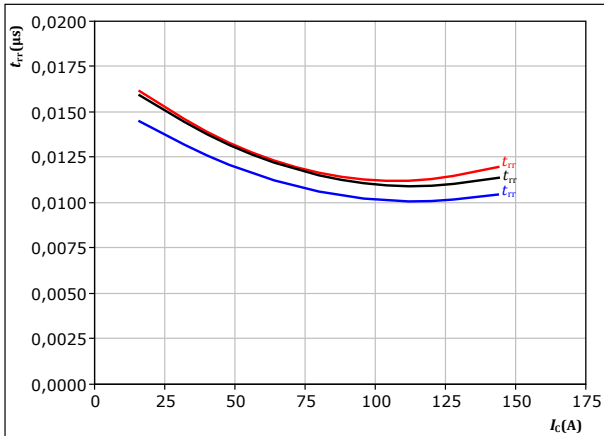
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $I_c = 80$ A

figure 19.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at

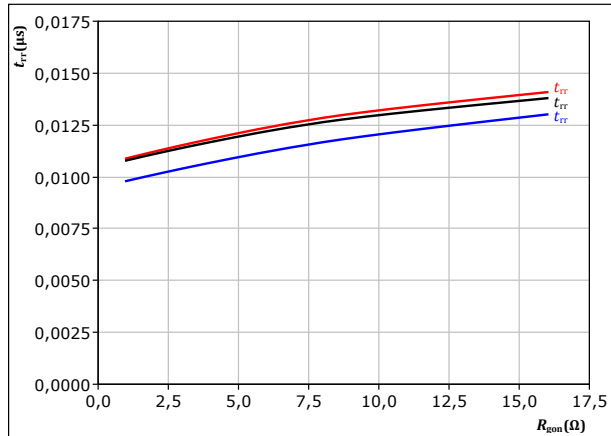
$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C
125 °C
150 °C

figure 20.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $I_c = 80$ A

T_j : 25 °C
125 °C
150 °C



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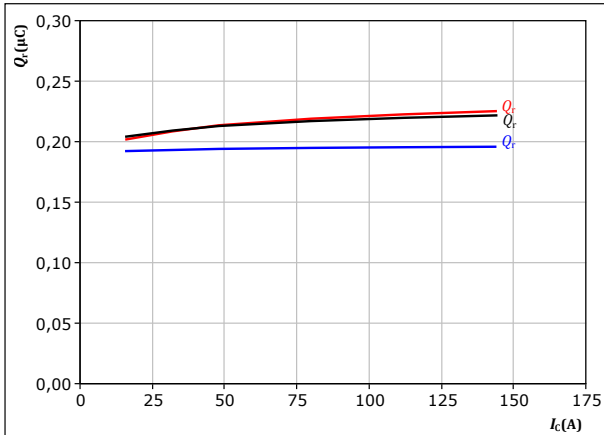
Boost Switching Characteristics

figure 21.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

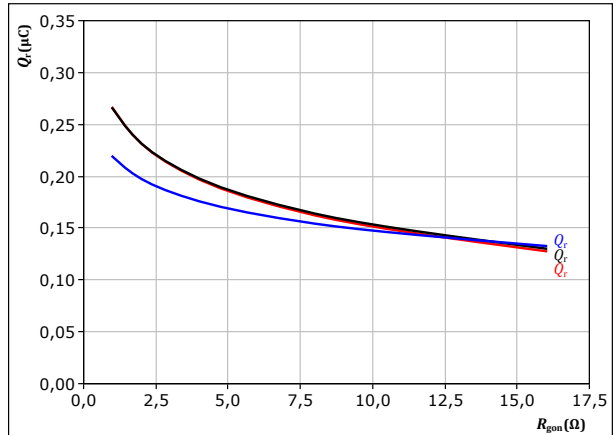
T_j : 25 °C
125 °C
150 °C

figure 22.

FWD

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $I_c = 80$ A

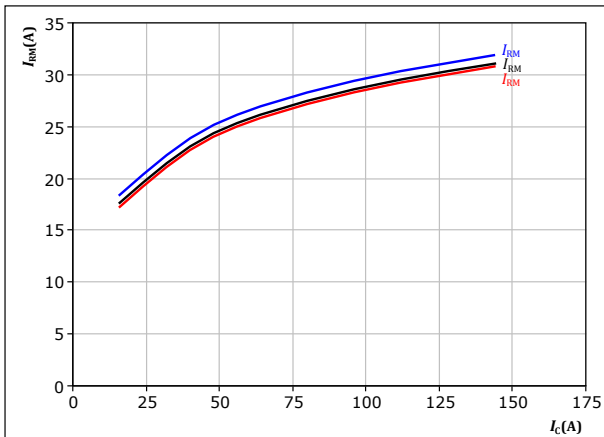
T_j : 25 °C
125 °C
150 °C

figure 23.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

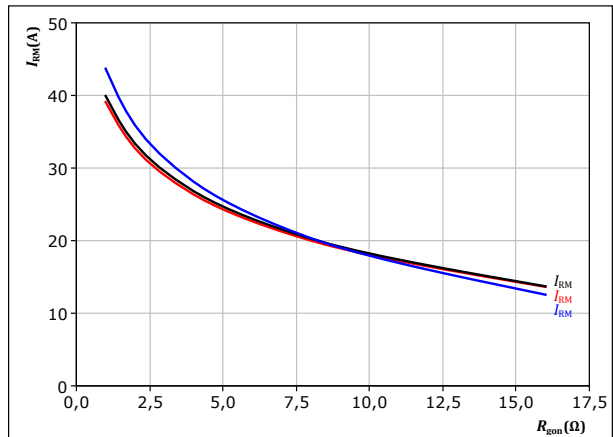
T_j : 25 °C
125 °C
150 °C

figure 24.

FWD

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $I_c = 80$ A

T_j : 25 °C
125 °C
150 °C



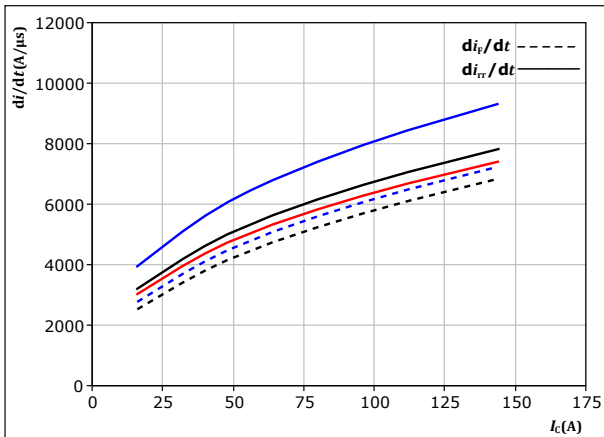
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Boost Switching Characteristics

figure 25. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



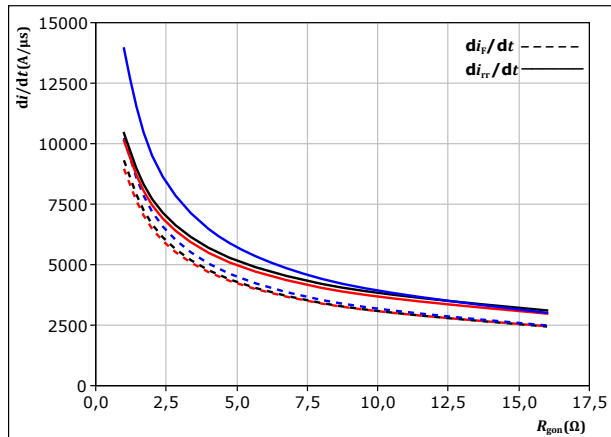
With an inductive load at

$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 26. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_r/dt = f(R_{gon})$



With an inductive load at

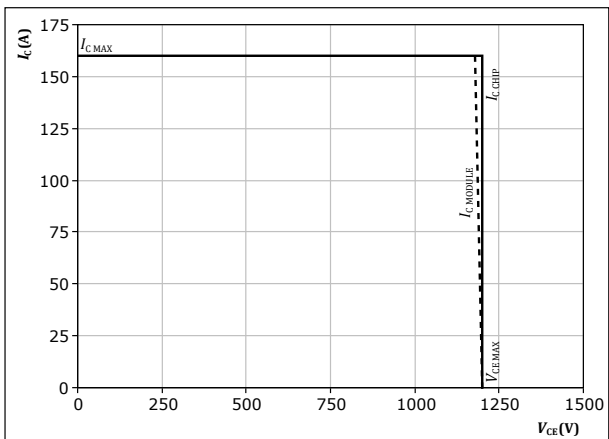
$V_{CE} = 700$ V
 $V_{GE} = 0/15$ V
 $I_C = 80$ A

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 27. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



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Boost Switching Definitions

figure 28. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

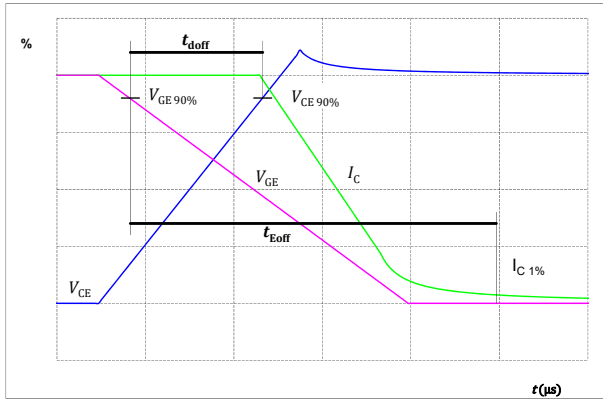


figure 29. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

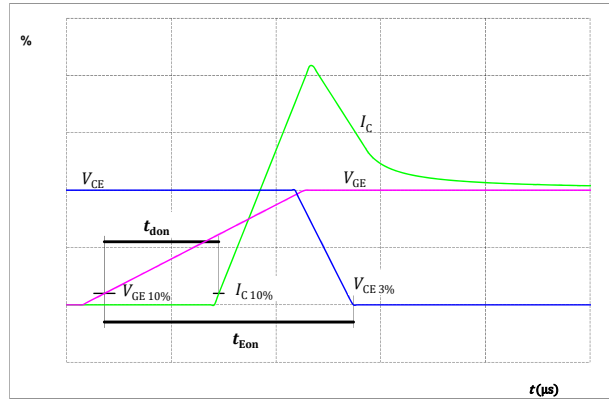


figure 30. IGBT

Turn-off Switching Waveforms & definition of t_f

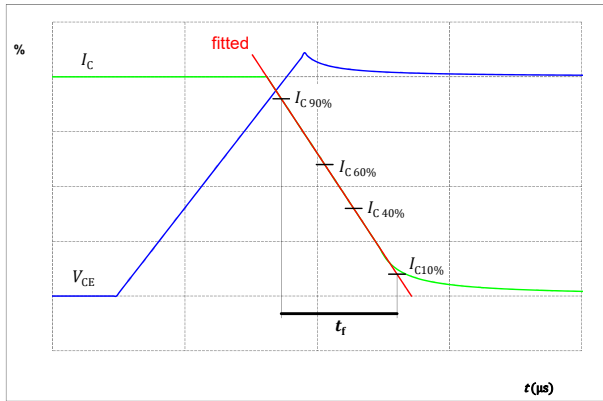
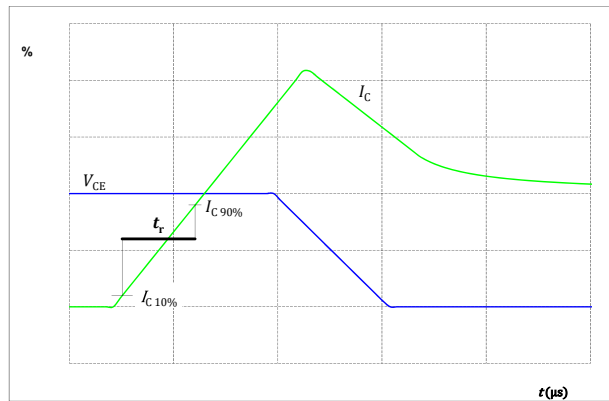


figure 31. IGBT

Turn-on Switching Waveforms & definition of t_r





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Boost Switching Definitions

figure 32.

FWD

Turn-off Switching Waveforms & definition of t_{rr}

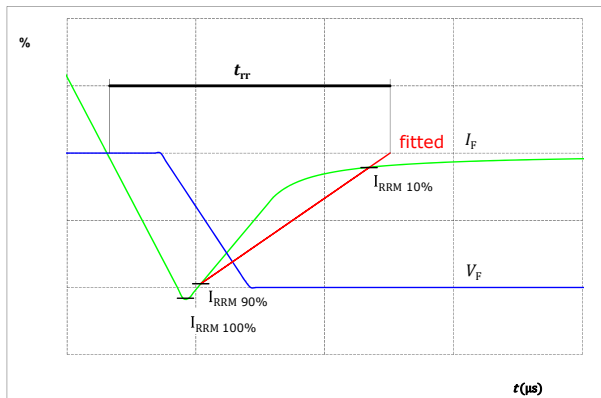
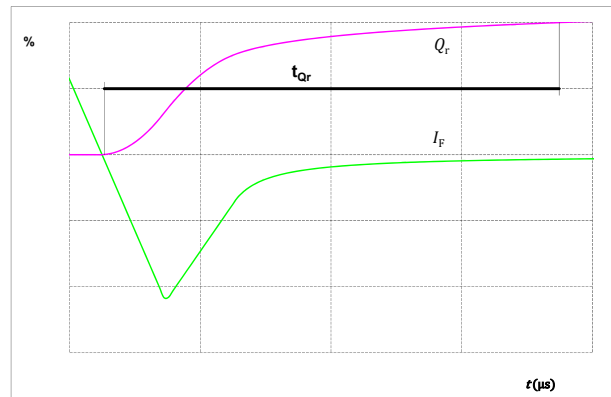


figure 33.

FWD


Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





10-PG123BA080SH11-LN68L33T
datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-PG123BA080SH11-LN68L33T
With thermal paste	10-PG123BA080SH11-LN68L33T-/3/

Marking							
	Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNN- TTTTTVV		WWYY	UL VIN	LLLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTVV	LLLLL	SSSS	WWYY			

Pin table [mm]			
Pin	X	Y	Function
1	52,2	0	DC+Boost2
2	52,2	2,8	DC+Boost2
3	43,9	0	S29
4	43,9	2,8	G29
5	37,9	0	DC-Boost21
6	37,9	2,8	DC-Boost21
7	32,1	0	DC-Boost12
8	32,1	2,8	DC-Boost12
9	26,1	0	S27
10	26,1	2,8	G27
11	17,4	0	DC+Boost1
12	17,4	2,8	DC+Boost1
13	14,6	0	DC+Boost1
14	14,6	2,8	DC+Boost1
15	6	0	S25
16	6	2,8	G25
17	0	0	DC-Boost11
18	0	2,8	DC-Boost11
19	0	25,4	Boost11
20	0	28,2	Boost11
21	8,5	25,4	DC+In11
22	8,5	28,2	DC+In11
23	18,7	25,4	DC+In12
24	18,7	28,2	DC+In12
25	28,1	28,2	Boost12
26	30,9	28,2	Boost12
27	39,2	28,2	Boost21
28	42	28,2	Boost21
29	52,2	28,2	DC+In21
30	52,2	25,4	DC+In21
31	36,3	19,2	Therm1
32	33,3	19,2	Therm2

Outline

center of press-fit pin head
pin head type "H", PCB plated through-hole Ø1 mm +0.09 / -0.06
for further PCB design rules refer to the latest handling instruction

12.7 ± 0.1
16.5 ± 0.1

26.1

14.1

Y

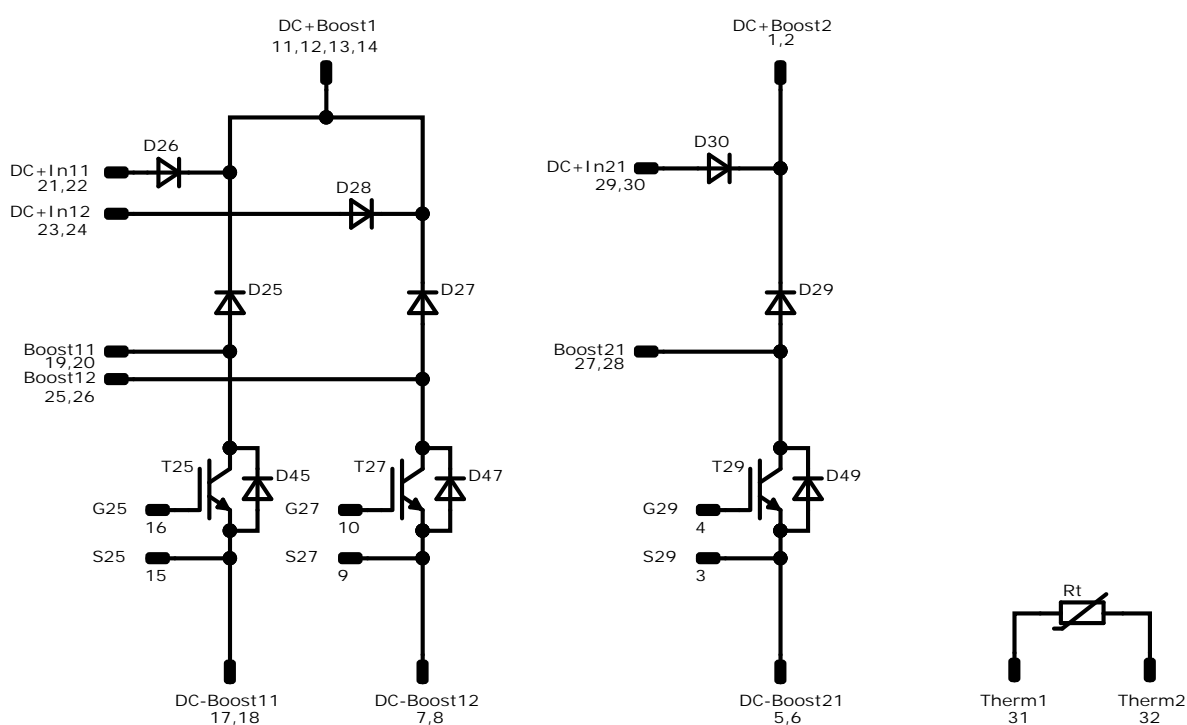
X

Tolerance of pinpositions: ±0.4mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



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Pinout




Identification

ID	Component	Voltage	Current	Function	Comment
T25, T27, T29	IGBT	1200 V	80 A	Boost Switch	
D25, D27, D29	FWD	1200 V	30 A	Boost Diode	
D45, D47, D49	Rectifier	1600 V	28 A	Boost Sw. Protection Diode	
D26, D28, D30	Rectifier	1600 V	50 A	ByPass Diode	
Rt	Thermistor			Thermistor	



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10-PG123BA080SH11-LN68L33T
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
Handling instruction				
Handling instructions for <i>flow</i> 1 packages see vincotech.com website.				
Package data				
Package data for <i>flow</i> 1 packages see vincotech.com website.				
Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				
UL recognition and file number				
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.				

Document No.:	Date:	Modification:	Pages
10-PG123BA080SH11-LN68L33T-D1-14	12 Mar. 2021		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.